

REGULATORY COMPLIANCE











ITEM DESCRIPTION

Quartz Crystal Resonator HC49/US Short Thru-Hole Metal Resistance Weld Seal

ELECTRICAL SPECIFICATIONS				
Nominal Frequency	1.8432MHz to 65MHz			
Frequency Tolerance/Stability	±50ppm at 25°C, ±100ppm over 0°C to +70°C ±50ppm at 25°C, ±100ppm over -20°C to +70°C ±50ppm at 25°C, ±100ppm over -40°C to +85°C ±30ppm at 25°C, ±50ppm over 0°C to +70°C ±30ppm at 25°C, ±50ppm over -20°C to +70°C ±30ppm at 25°C, ±50ppm over -40°C to +85°C ±15ppm at 25°C, ±30ppm over 0°C to +70°C ±15ppm at 25°C, ±30ppm over -20°C to +70°C ±15ppm at 25°C, ±30ppm over -40°C to +85°C ±15ppm at 25°C, ±20ppm over -40°C to +85°C ±15ppm at 25°C, ±20ppm over 0°C to +70°C ±15ppm at 25°C, ±20ppm over -20°C to +70°C ±15ppm at 25°C, ±15ppm over -40°C to +85°C ±10ppm at 25°C, ±15ppm over -20°C to +70°C ±10ppm at 25°C, ±15ppm over -20°C to +70°C			
Aging at 25°C	±5ppm/year Maximum			
Load Capacitance	Series Resonant, 10pF Parallel Resonant to 50pF Parallel Resonant			
Shunt Capacitance	7pF Maximum			
Equivalent Series Resistance	See the Equiv <mark>alent S</mark> eries Resistance (ESR), Mode of Op <mark>eration</mark> , and Crystal Cut Table Below			
Mode of Operation	AT-Cut Fundamental (Only available over Nominal Frequency range of 1.8432MHz to 27MHz) AT-Cut Third Overtone (Only available over Nominal Frequency range of 24MHz to 65MHz)			
Drive Level	2mWatt Maximum			
Storage Temperature Range	-40°C to +125°C			
Insulation Resistance	500 Megaohms Minimum (Measured at 100Vdc)			

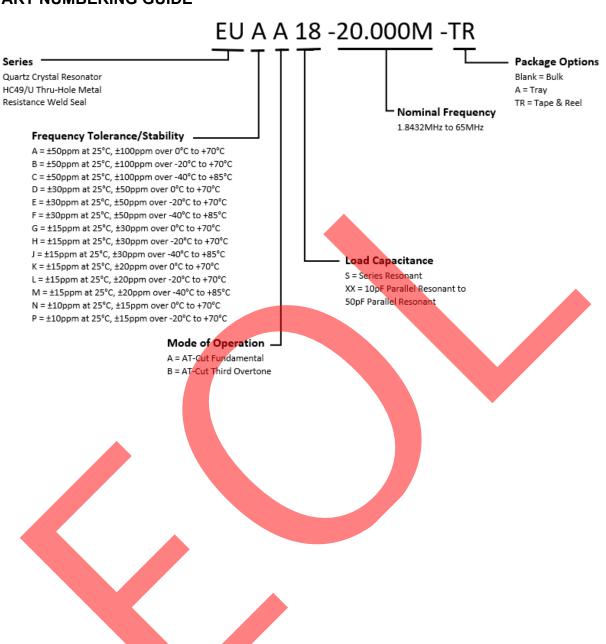
EQUIVALENT SERIES RESISTANCE (ESR), MODE OF OPERATION AND CRYSTAL CUT

Frequency Range	ESR (Ohms Max)	Mode	Frequency Range	ESR (Ohms Max)	Mode
1.8432MHz to 1. 999999MHz	650	AT-Cut Fundamental	4.1MHz to 4.999999MHz	80	AT-Cut Fundamental
2MHz to 2.399999MHz	550	AT-Cut Fundamental	5MHz to 5.999999MHz	75	AT-Cut Fundamental
2.4MHz to 2.999999MHz	350	AT-Cut Fundamental	6MHz to 6.999999MHz	50	AT-Cut Fundamental
3MHz to 3.1999999MHz	250	AT-Cut Fundamental	7MHz to 7.999999MHz	40	AT-Cut Fundamental
3.2MHz to 3.4999999MHz	200	AT-Cut Fundamental	8MHz to 9.999999MHz	35	AT-Cut Fundamental
3.5MHz to 3.5999999MHz	180	AT-Cut Fundamental	10MHz to 12.999999MHz	30	AT-Cut Fundamental
3.6MHz to 3.8999999MHz	150	AT-Cut Fundamental	13MHz to 27MHz	25	AT-Cut Fundamental
3.9MHz to 3.999999MHz	120	AT-Cut Fundamental	24MHz to 29.999999MHz	60	AT-Cut Third Overtone
4MHz to 4.0999999MHz	100	AT-Cut Fundamental	30MHz to 65MHz	40	AT-Cut Third Overtone

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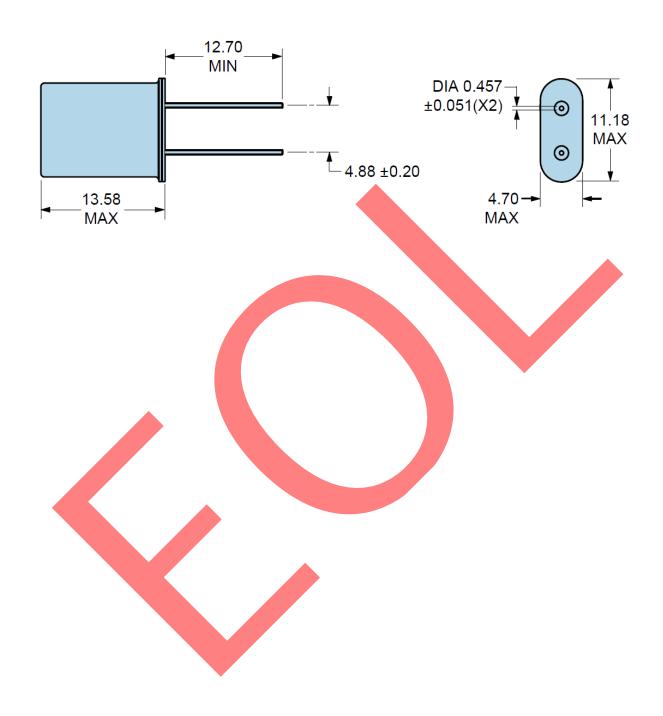


PART NUMBERING GUIDE





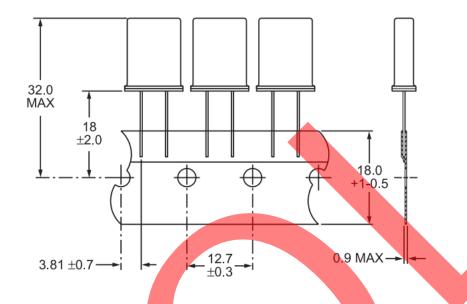
MECHANICAL DIMENSIONS

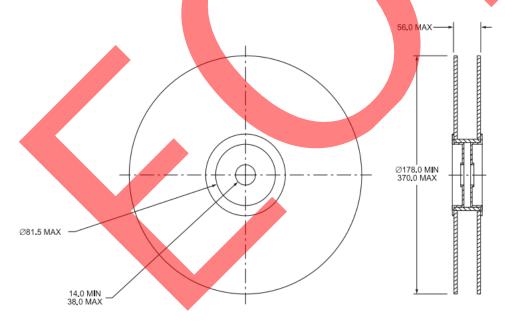




TAPE & REEL

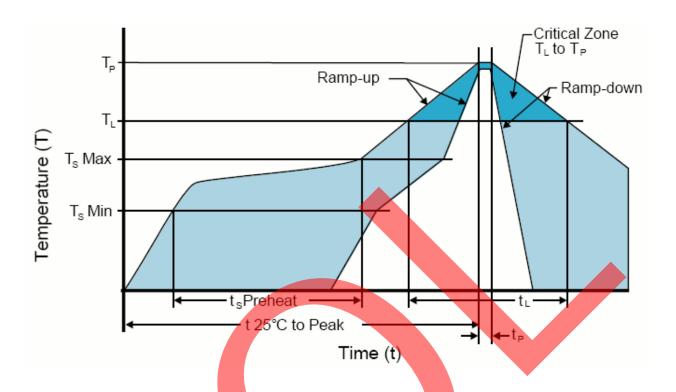
- 1000 pieces per reel
- Compliant to EIA-481
- All Dimensions in Millimeters







RECOMMENDED SOLDER REFLOW METHOD



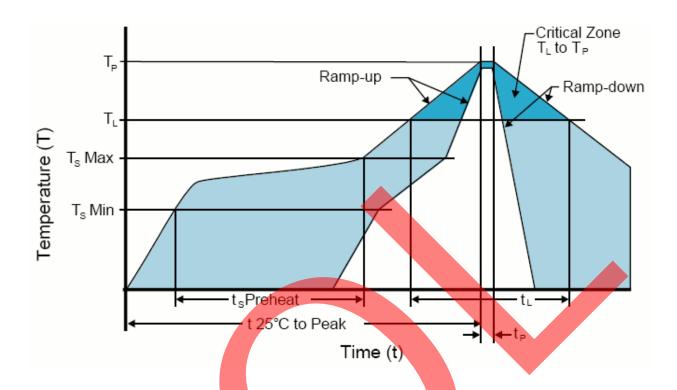
HIGH TEMPERATURE INFRARED/CONVECTION					
	3°C/Second Maximum				
Preheat					
- Temperature Minimum (T _s MIN)	150°C				
- Temperature Typical (T _S TYP)	175°C				
- Temperature Maximum(T _s MAX)	200°C				
- Time (t _s)	60 - 180 Seconds				
Ramp-up Rate (T _L to T _P)	3°C/Second Maximum				
Time Maintained Above:					
- Temperature (T _L)	217°C				
- Time (t∟)	60 - 150 Seconds				
Peak Temperature (T _P)	260°C Maximum for 10 Seconds Maximum				
Target Peak Temperature(T _P Target)	250°C +0/-5°C				
Time within 5°C of actual peak (t _p)	20 - 40 Seconds				
Ramp-down Rate	6°C/Second Maximum				
Time 25°C to Peak Temperature (t)	8 Minutes Maximum				
Moisture Sensitivity Level	Level 1				
Additional Notes	Temperatures shown are applied to body of device.				

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)



RECOMMENDED SOLDER REFLOW METHOD



LOW TEMPERATURE INFRARED/CONVECTION				
T _s MAX to T _L (Ramp-up Rate)	5°C/Second Maximum			
Preheat				
- Temperature Minimum (T _s MIN)	N/A			
- Temperature Typical (T _s TYP)	150°C			
- Temperature Maximum(T _s MAX)	N/A			
- Time (t _s)	30 - 60 Seconds			
Ramp-up Rate (T _L to T _P)	5°C/Second Maximum			
Time Maintained Above:				
- Temperature (T _L)	150°C			
- Time (t∟)	200 Seconds Maximum			
Peak Temperature (T _P)	245°C Maximum			
Target Peak Temperature (T _P Target)	245°C Maximum 2 Times / 230°C Maximum 1 Time			
Time within 5°C of actual peak (tp)	10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time			
Ramp-down Rate	5°C/Second Maximum			
Time 25°C to Peak Temperature (t)	N/A			
Moisture Sensitivity Level	Level 1			
Additional Notes	Temperatures shown are applied to body of device.			

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)